



Blockchain for Vehicular Networks

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Message from the Guest Editors

Dear Colleagues,

Recently, blockchain technology has been studied and applied to many diverse fields because of its properties, including immutability, consensus among distrusted nodes, and cryptographic security. In this Special Issue, we are particularly interested in identifying the potential problems with the future vehicular networks, and for finding solutions for these issues based on blockchain technology.

The topics of interest include, but are not limited to, the following:

- Design of blockchain for vehicular networks
- Implementation of blockchain for vehicular networks
- Simulator to evaluate blockchain for vehicular networks
- Application of smart contract to vehicular networks
- Security of blockchain for vehicular networks
- Mathematical analysis of blockchain for vehicular networks
- Blockchain-based security services for vehicular networks
- Low latency blockchain for vehicular networks

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Guest Editors





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Message from the Editor-in-Chief

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